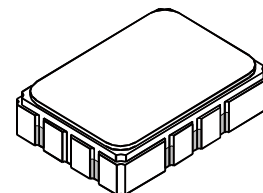




- **Designed for GPS Applications**
- **Quartz Temperature Stability**
- **Small Size**
- **Hermetic 7 x 5 mm Surface-mount Case**
- **Complies with Directive 2002/95/EC (RoHS)**

**SF1120B****298.74 MHz
SAW Filter****SMP-03****Absolute Maximum Ratings**

Rating	Value	Units
Maximum Incident Power in Passband	+10	dBm
Max. DC voltage between any 2 terminals	30	VDC
Storage Temperature Range	-40 to +85	°C
Suitable for lead-free soldering - Max. Soldering Profile	260°C for 30 s	

Electrical Characteristics

Characteristic	Sym	Notes	Min	Typ	Max	Units
Nominal Center Frequency	f_C	1	298.740			MHz
Passband Insertion Loss at f_C	IL	1, 2			12.0	dB
1 db Passband	BW_1		± 750			kHz
3 db Passband	BW_3		± 1100	± 1150	± 1300	kHz
Amplitude Ripple over $f_C \pm 1.0$ MHz					1.0	dB _{p-p}
Group Delay Variation over $f_C \pm 1.0$ MHz	GDV				250	ns _{p-p}
Rejection $f_C - 25$ to $f_C - 5.0$ and $f_C + 5.0$ to $f_C + 25$ MHz		1, 2, 3				dB
Operating Temperature Range	T_A	1	-20		+75	°C

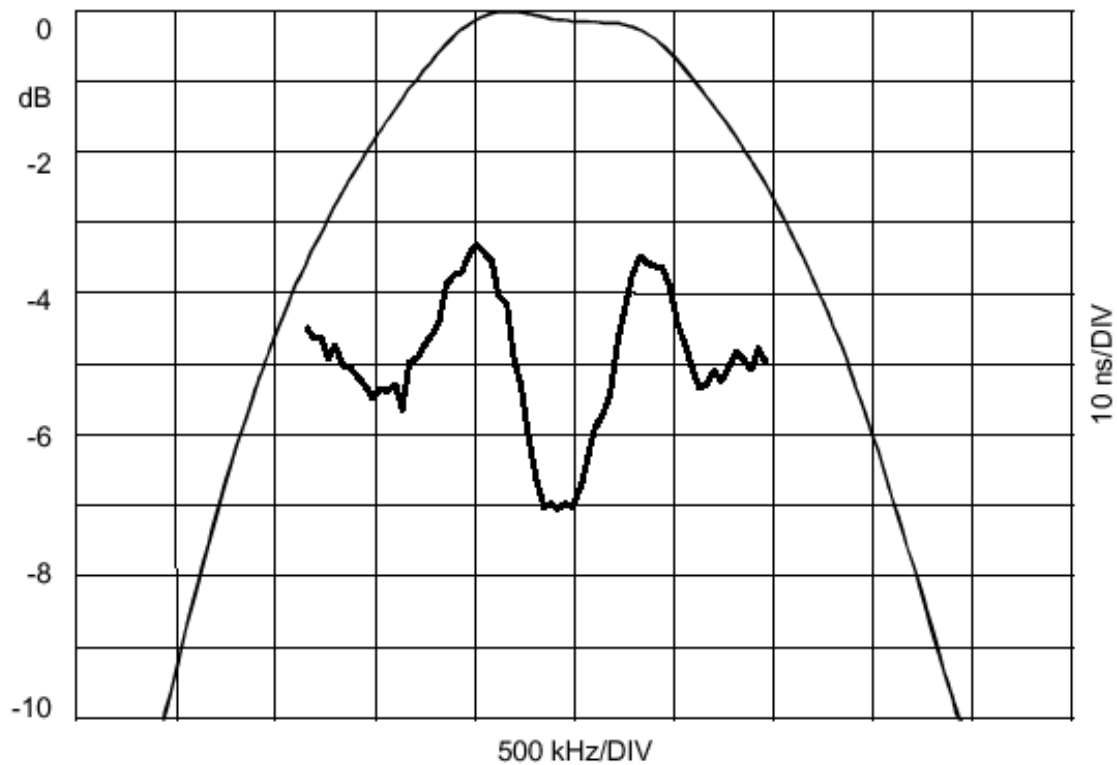
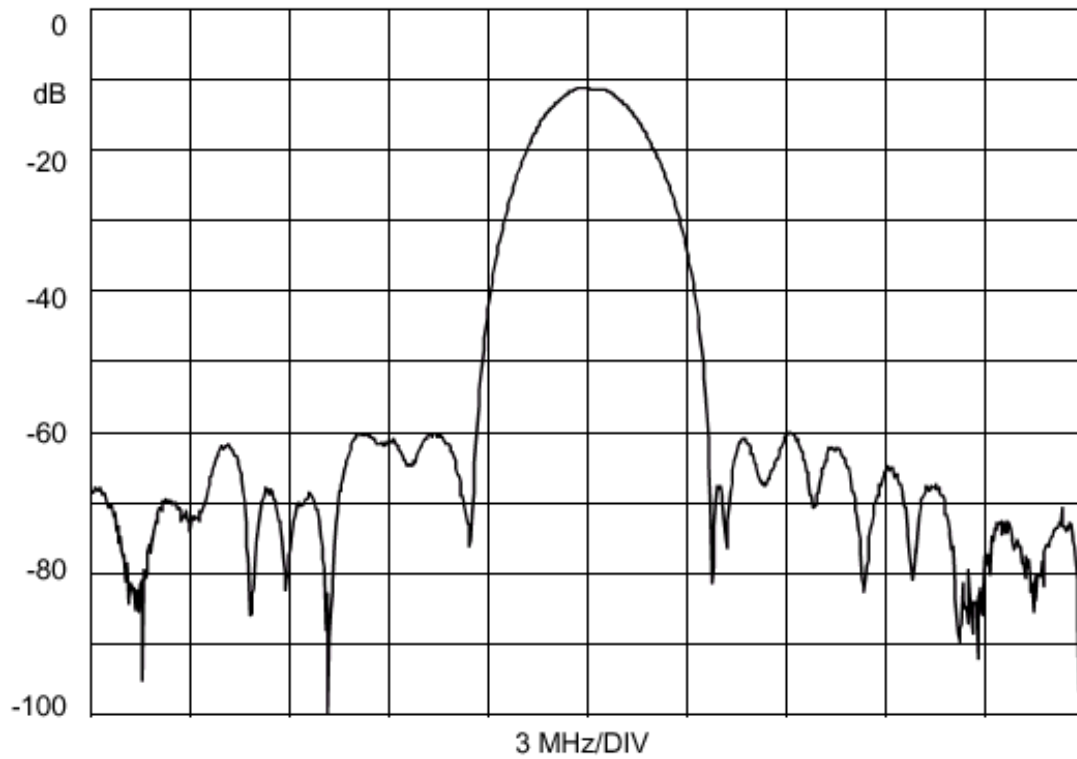
Matching to Unbalanced Impedance	External L-C to 1k Ω (Port 1) and 200 Ω (Port 2)	
Case Style	6	SMP-03 7 x 5 mm Nominal Footprint
Lid Symbolization (YY = year, WW = week)		RFM SF1120B YYWW

Notes:

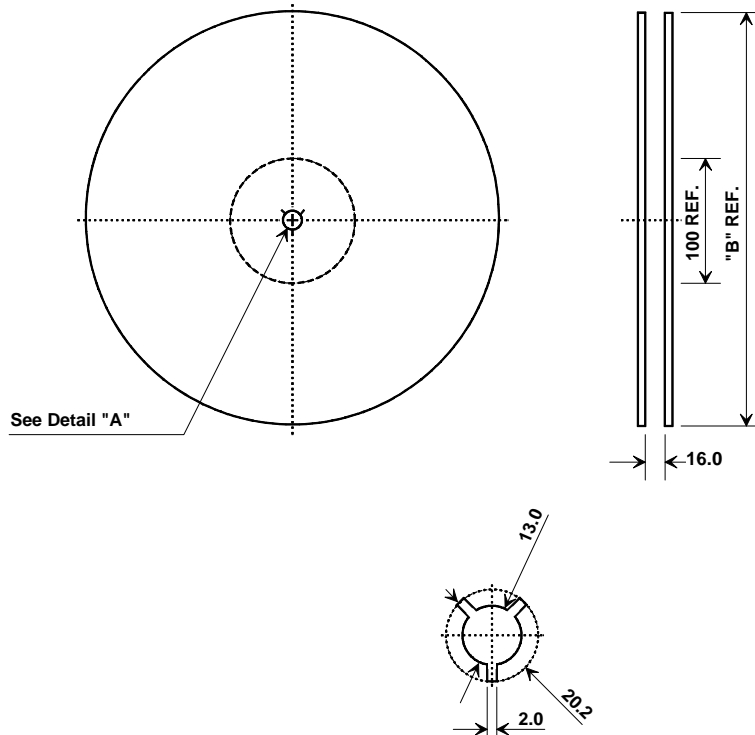
1. Unless noted otherwise, all specifications apply over the operating temperature range with filter soldered to the specified demonstration board with impedance matching to 50 Ω and measured with 50 Ω network analyzer.
2. Unless noted otherwise, all frequency specifications are referenced to the nominal center frequency, f_C .
3. Rejection is measured as attenuation below the minimum IL point in the passband. Rejection in final user application is dependent on PCB layout and external impedance matching design. See Application Note No. 42 for details.
4. "LRIP" or "L" after the part number indicates "low rate initial production" and "ENG" or "E" indicates "engineering prototypes."
5. The design, manufacturing process, and specifications of this filter are subject to change.
6. Tape and Reel Standard ANSI / EIA 481.
7. Either Port 1 or Port 2 may be used for either input or output in the design. However, impedances and impedance matching may vary between Port 1 and Port 2, so that the filter must always be installed in one direction per the circuit design.
8. US and international patents may apply.
9. Electrostatic Sensitive Device. Observe precautions for handling.

**Electrical Connections**

Connection	Terminals
Port 1	1, 10
Port 2	5, 6
Case Ground	All others

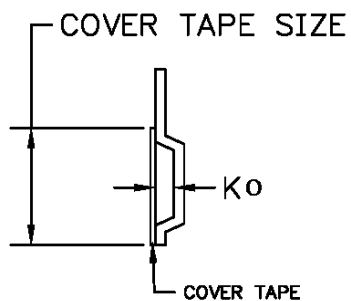


Tape and Reel Specifications

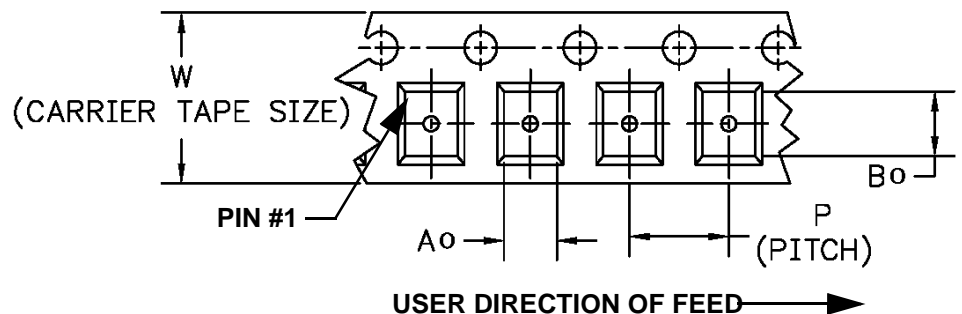


"B"		Quantity Per Reel
Inches	millimeters	
7	178	500
13	330	2000

COMPONENT ORIENTATION and DIMENSIONS

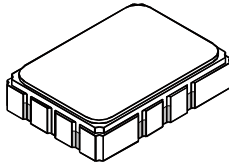


Carrier Tape Dimensions	
Ao	5.5 mm
Bo	7.5 mm
Ko	2.0 mm
Pitch	8.0 mm
W	16.0 mm

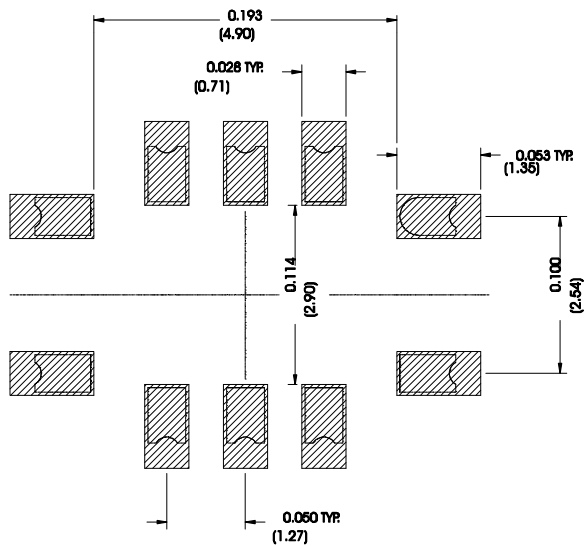


SMP-03 Case

10-Terminal Ceramic Surface-Mount Case
7 x 5 mm Nominal Footprint



Recommended PCB Footprint



Case Dimensions						
Dimension	mm			Inches		
	Min	Nom	Max	Min	Nom	Max
A	6.80	7.00	7.20	0.268	0.276	0.283
B	4.80	5.00	5.20	0.189	0.197	0.205
C		1.65	2.00		0.065	0.079
D		0.60			0.024	
E		2.54			0.100	
H		1.0			0.039	
J		5.00			0.197	
K		3.00			0.118	
P		1.27			0.050	

Electrical Connections		
Connection		Terminals
Port 1	Input or Return	10
	Return or Input	1
Port 2	Output or Return	5
	Return or Output	6
Ground		All others
Single Ended Operation		Return is ground
Differential Operation		Return is hot

Materials	
Solder Pad Termination	Au plating 30 - 60 ulnches (76.2-152 uM) over 80-200 ulnches (203-508 uM) Ni.
Lid	Fe-Ni-Co Alloy Electroless Nickel Plate (8-11% Phosphorus) 100-200 ulnches Thick
Body	Al ₂ O ₃ Ceramic
Pb Free	

